SCHEME OF MASTER OF TECHNOLOGY

Electronics & Telecommunication Engineering (VLSI & Embedded System Design)

M. Tech. [Third Semester]

Sr. No.	Board Of Studies	Code	Subject		Weekly Teaching hours		Scheme of Examination			Grand Total	Credits
	Studies			L	Т	Р	ESE	СТ	TA		
1	E&Tc	572311(28)	ARM Processor and controller		1		100	20	20	140	4
2	E&Tc	Elective III		3	1		100	20	20	140	4
3	E&Tc	572321(28)	Preliminary Work on Dissertation			28	100		100	200	14
4	E&Tc	572322(280	Seminar on Industrial Training & Dissertation			3			20	20	2
	Total					31	300	40	160	500	24

Table—3 Elective-III

Sr.No	Board Of Study	Subject Code	Subject				
1	Electronics & Telecom	560331 (28)	Algorithm for VLSI Design Automation				
2	Electronics & Telecom	572331(28)	Electromagnetic Interference and Compatibility in system Design				
3	Electronics & Telecom	572332(28)	VLSI signal processing.				

Course: M. Tech. IIIrd Sem Branch: Electronics & Telecom

Subject: ARM Processor and controller Specialization: VLSI & Embedded System Design

Total Theory Periods: 40 Code: 572311(28)

Total Marks in End Semester Exam.: 100

Minimum number of class test to be conducted: 02

ARM Processor and Controller

UNIT I

Introduction to 16 / 32-bit Micro controllers: ARM 7/ARM 9 architecture, ARM Microcontrollers and Processor Cores, ARM Architecture and Organization, ARM/THUMB Programming Model, ARM/THUMB Instruction Set, ARM Exception Handling, More ARM Instructions, ARM/THUMB Assembly Programming

UNIT II

Data handling, interfacing with Memory, Interrupts, Timers, ARM Bus. I/O Devices, Controllers, Simple & Autonomous I/O Controllers,

UNIT III

Parallel, Multiplexed, Tristate, and Open-Drain Buses, Bus Protocols, Serial Transmission Techniques & Standards, Wireless protocols CAN & advanced Buses.

UNIT IV

Design Methodology, Design Flow, Architecture Exploration, Functional Design, Functional Verification, Synthesis, Physical Design,

UNIT V

Design Optimization, Area Optimization, Timing Optimization, Power Optimization, Design for Test, Fault Models and Fault Simulation, Scan Design and Boundary Scan, Built-In Self Test (BIST), Nontechnical Issues.

BOOKS

1. Data books of ARM7/ARM9 J. Staunstrup and W. Wolf, editors, Hardware/Software Co-Design: Principles and Practice, Kluwer Academic Publishers, 1997.

Reference:

- 1. ARM System-on-Chip Architecture, by Steve Furber, Pearson Education Edition: 2nd
- 2. Arm System Developer'S Guide: Designing And Optimizing System Software (Paperback) by Sloss Andrew N. Et.Al, **Publisher:** Morgan Kaufmann Publishers **Edition:** 1st

Course: M. Tech. IIIrd Sem Branch: Electronics & Telecom

Subject: Algorithm for VLSI Design Automation Specialization: VLSI & Embedded System Design

Total Theory Periods: 40 Code: 560331(28)

Total Marks in End Semester Exam.: 100

Minimum number of class test to be conducted: 02

Algorithm for VLSI Design Automation

UNITI

Logic synthesis & verification: Introduction to combinational logic synthesis, Binary Decision Diagram, Hardware models for High-level synthesis.

UNIT II

VLSI automation Algorithms: Partitioning: problem formulation, classification of partitioning algorithms, Group migration algorithms, simulated annealing & evolution, other partitioning algorithms. Placement, floor planning & pin assignment: problem formulation, simulation base placement algorithms, other placement algorithms, constraint based floor planning, floor planning algorithms for mixed block & cell design. General & channel pin assignment.

UNIT III

Global Routing: Problem formulation, classification of global routing algorithms, Maze routing algorithm, line probe algorithm, Steiner Tree based algorithms, ILP based approaches.

UNIT IV

Detailed routing: problem formulation, classification of routing algorithms, single layer routing algorithms, two layer channel routing algorithms, three layer channel routing algorithms, and switchbox routing algorithms.

UNIT V

Over the cell routing & via minimization: two layers over the cell routers, constrained & unconstrained via minimization. Compaction: problem formulation, one-dimensional compaction, two dimension-based compaction, hierarchical compaction

Text:

- 1. Naveed Shervani, "Algorithms for VLSI physical design Automation", Kluwer Academic Publisher, Second edition.
- 2.Trimburger," Introduction to CAD for VLSI", Kluwer Academic publisher, 2002

References:

- 1. Christophn Meinel & Thorsten Theobold, "Algorithm and Data Structures for VLSI Design", KAP,2002.
- 2. Rolf Drechsheler: "Evolutionary Algorithm for VLSI", Second edition

Course: M. Tech. IIIrd Sem Branch: Electronics & Telecom

Subject: Electromagnetic Interference and Compatibility in Specialization: VLSI & Embedded System Design

system Design

Total Theory Periods: 40 Code: 572331(28)

Total Marks in End Semester Exam.: 100

Minimum number of class test to be conducted: 02

UNIT 1

EMI Environment

Sources of EMI conducted and radiated EMI, transient EMI, EMI-EMC definitions and units of parameters.

UNIT 2

EMI Coupling Principles

Conducted, radiated and transient coupling, common independence ground coupling, radiated common mode and ground loop coupling, radiated differential mode coupling, near field cable to cable coupling, power mains and power supply coupling.

UNIT 3

EMI Specification/Standards & Measurements

Unit of specifications, civilian standards military standards. EMI test instruments/systems, EMI test, EMI Shielded chamber, open area test site, TEM Cell antennas, conductors injectors/couplers, military test method and procedures, calibration procedures.

UNIT 4

EMI Control Techniques

Shielding, filtering, grounding, bonding, isolation transformer, transient suppressors, cable routing, signal control, component selection and mounting.

UNIT 5

EMC Design of PCBs

PCB traces cross talk, impedance control, power distribution decoupling, zoning, motherboard designs and propagation delay performance models.

Books:

1. Bernhard Keiser, "Principles of Electromagnetic Compatibility", Artech house, 3rd Ed., 1986. **Reference**:

1. Henry W.Ott, "Noise Reduction Techniques in Electronic Systems", John wiley and Sons. 1988.

Course: M. Tech. IIIrd Sem Branch: Electronics & Telecom

Subject: VLSI Signal Processing Specialization: VLSI & Embedded System Design

Total Theory Periods: 40 Code: 572332(28)

Total Marks in End Semester Exam.: 100

Minimum number of class test to be conducted: 02

VLSI Signal Processing (Elective III)

UNIT 1

Introduction to DSP systems – Iteration Bound – Pipelined and parallel processing.

UNIT 2

Retiming – unfolding – algorithmic strength reduction in filters and transforms.

UNIT 3

Systolic architecture design – fast convolution – pipelined and parallel recursive and adaptive filters.

UNIT 4

Scaling and round off noise – digital lattice filter structures – bit level arithmetic architecture – redundant arithmetic.

UNIT 5

Numerical strength reduction – synchronous, wave and asynchronous pipe lines – low power design – programmable digit signal processors.

Book:

- 1. Keshab K. Parthi, "VLSI Digital signal processing systems, design and implementation", Wiley, Inter Science, 1999.
- 2. Mohammad Isamail and Terri Fiez, "Analog VLSI signal and information processing", Mc Graw Hill
- 3. S.Y. Kung, H.J. White House, T. Kailath, "VLSI and Modern Signal Processing", Prentice Hall, 1985.

Reference:

4. Jose E. France, Yannis Tsividis, "Design of Analog - Digital VLSI Circuits for Telecommunication and Signal Processing", Prentice Hall, 1994